Impurity complexes and conductivity of Ga-doped ZnO

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Using hybrid functional theory together with experimental measurements, we investigate the influence of gallium impurities and their complexes on electrical properties of ZnO. In contrast to the behavior of isolated Ga impurities and native defects, the calculated formation energies of Ga complexes are consistent with our experimental data. We show that for high levels of Ga doping the acceptor behavior of $Ga_{Zn}-V_{Zn}$ and $Ga_{Zn}-O_i$ complexes explains the conductivity measurements and compensation levels in ZnO. The computed binding energies of these complexes are also consistent with the binding energies obtained from the measurements of the temperature dependence of carrier mobility. Our results show that the formation of defect complexes, often overlooked by theory, can be indispensable in capturing the defect physics.

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I. INTRODUCTION

Zinc oxide (ZnO) is a material of practical interest showing significant advantages in several areas including: ultraviolet optoelectronic devices, transparent conducting oxide (TCO) thin films, and spintronics.¹ A large band gap (3.3 eV at room temperature), large exciton binding energy (60 meV),² high electron mobility, visible transparency, and high emission efficiency also make ZnO attractive for light-emitting devices. These advantages have sparked interest in understanding the physics of defects and impurities in ZnO.³ However, due to known doping asymmetry, a stable *p*-type ZnO has been difficult to fabricate,^{4–7} delaying the development of ZnO-based devices. On the other hand, *n*-type ZnO heavily doped with Ga⁸ has been suggested as a material with potential application as a transparent electrode in dye-sensitized solar cells,^{9,10} light-emitting devices,¹¹ and transparent thin film transistors.¹²

The first principles calculations of defects and impurities¹³ using the local density approximation (LDA) and generalized gradient approximation (GGA) to the density functional theory (DFT) have been the subject of intense debate^{14,15} due to their notorious inconsistency, particularly in the case of ZnO.¹⁶⁻²⁴ The most widely studied is the case of oxygen vacancy in ZnO, where the defect formation energies and the thermodynamic transition levels computed by different approaches within LDA/GGA vary by several electronvolts.²⁵ The reason for such a large discrepancy lies in the variety of correction schemes to the LDA/GGA value of the band gap ($E_g = 0.67$ eV within LDA-DFT). Recently it has been demonstrated for a variety of defects in different materials that hybrid functional calculations can dramatically improve the accuracy of the computed defect formation energies.^{26–28} Presently, the hybrid functional approach provides a practical and affordable method for illuminating the defect physics. In its ability to reproduce the experimental band gaps, it is inferior only to the quasiparticle GW method,²⁹ which is very computationally expensive.

In this paper we demonstrate that by using hybrid functional calculations, we can reliably predict the formation properties of Ga impurities and their complexes in ZnO. We calculate the formation energies as a function of the Fermi level of native defects in ZnO, such as interstitial oxygen O_i , Zn

vacancies V_{Zn} , as well as dopant Ga in the interstitial and substitutional sites, i.e. Ga_i and Ga_{Zn} . Due to both Ga_i and Ga_{Zn} donor-like behavior, our calculations suggest that the Coulomb interactions between Ga and acceptor-like defects, such as O_i and V_{Zn} , would lead to bound complexes. Furthermore, we show that these complexes, rather than isolated impurities, dominate the electrical properties of Ga-doped ZnO. The calculated energetics of Ga_{Zn} - V_{Zn} and Ga_{Zn} - O_i complexes are consistent with Hall effect measurements in Ga-doped ZnO (GZO) samples grown on a-sapphire substrates by plasmaenhanced molecular beam epitaxy (PE MBE) under O-rich and O-deprived conditions.

II. METHOD OF CALCULATION

Specifically, our calculations are based on the Heyd-Scuseria-Ernzerhof (HSE)³⁰ hybrid functional implemented in the VASP code,³¹ with the projector augmented wave (PAW) method.^{32,33} In a hybrid functional calculation, the local density exchange correlation part of the density functional is mixed with a Fock-type exchange part in varying proportions. In the HSE case, the Fock exchange interactions are separated into long- and short-range parts. The nonlocal Fock exchange potential is screened at long distances (similar to a screened exchange approach),^{34,35} and the long-ranged part is replaced with an approximate semilocal expression. It is also often useful to tune the amount of exact exchange for a particular material in order to obtain the best agreement of computed band gap with experiment, so-called α -tuned hybrid functionals. We use the α -tuned HSE hybrid functional, where the amount of exact exchange is set to be 37.5%. This functional has been shown to most accurately reproduce both the band gap and the lattice properties,²⁷ which are necessary for capturing the correct defect energetics. This approach has recently been used to describe the formation energies and thermodynamic transition levels of various defects in ZnO.²⁷ The screening parameter in HSE was kept at 0.2 Å⁻¹. The 3d electrons of Ga are treated as the core electrons, while Zn 3d, 4s, 4p, and O 2s, 2p are considered as valence electrons. The resulting band gap of 3.43 eV is in excellent agreement with the low-temperature experimental value. The calculated lattice parameters for wurtzite ZnO a = 3.241 Å and c = 5.258 Å also agree with the experiment well, where a = 3.242 Å and c = 5.188 Å. Supercells with 72 atoms in the unit were used. All atomic structures were relaxed to yield forces of 0.05eV/Å or less. The resulting geometries of $Ga_{Zn}-V_{Zn}$ and $Ga_{Zn}-O_i$ complexes are shown in Fig. 1. Significant lattice distortions are evident, especially in the case of Ga_{Zn} -O_i, where the Coulomb attraction reduces the Ga-O bond length by 0.24 Å. The plane-wave basis sets with 400 eV cutoff were used for electronic states calculations, while those with 300 eV cutoff were used for atomic structure relaxations. It must be noted that both the structure relaxation and the electronic structure were computed using the HSE hybrid functional. We found that an efficient relaxation using LDA/GGA with subsequent HSE calculations of electronic structure can introduce a very large error in the formation energy, particularly in cases where shallow occupied defect levels are formed. This is due to the hybridization of the defect states with valence or conduction band within LDA/GGA, which leads to the wrong charge density and incorrect forces and relaxation.²⁵ For example, in the case of the Zn vacancy V_{Zn}^{0} , V_{Zn}^{1-} , and V_{Zn}^{2-} , we compute this error to be 1.57, 0.93, and 0.24 eV, respectively. In all calculations Γ -point eigenvalues only were used. Due to the periodic boundary conditions, the spurious interactions between the defects leads to defect state dispersion, which in turn may lead to a relatively large error in the defect formation energy.¹³ In most cases considered here, this error is on the order of 0.1–0.2 eV and can be as high as 0.34 eV in the case of V_{Zn}^{0} . This error can be estimated by computing the HSE band structure and determining the occupied defect band weighted average, which gives a good approximation for the isolated defect level. The error in the formation energy was then corrected by using the difference between the defect band average and the eigenvalue at the Γ point. Spin polarized calculations were performed in all cases, as many defects form half-filled localized states. The defect formation energies E_f are defined in a standard way¹³

$$E_f = E_d - E_p - \sum_i \Delta n_i \mu_i + q E_F + \Delta E_M, \qquad (1)$$

where E_d is the energy of the supercell containing defect, E_p the energy of a pure nanocrystal, Δn_i the difference in number of atoms of *i*th kind, μ_i their atomic chemical potential, q the charge of the defect, E_F the Fermi energy (electrons are exchanged between a defect and the Fermi level), and ΔE_M the Makov–Payne^{36,37} energy correction for spurious interactions of charged defects due to the periodic boundary conditions. Here the Madelung energy was used, while dipole and higher-order interactions were deemed negligible.²⁷ The chemical potentials depend on growth conditions and sources of impurities and can be estimated from HSE calculations and experimental formation enthalpies. To simulate experimental growth conditions, we assume that zinc and oxygen chemical potentials μ_{Zn} and μ_{O} depend on oxygen pressure in the growth system. In our calculations for the oxygen-rich limit, $\mu_{Zn} =$ $\mu_{\text{Zn(metal)}} + \Delta H_{\text{ZnO}}$ and $\mu_{\text{O}} = \mu_{\text{O2}}/2$, and for the oxygen-poor limit, $\mu_{Zn} = \mu_{Zn(metal)}$ and $\mu_O = \mu_{O2}/2 + \Delta H_{ZnO}$, where ΔH_{ZnO} is the bulk ZnO enthalpy of formation. The HSE hybrid functional yields $\Delta H_{ZnO} = -3.32$ eV (in experiment $\Delta H_{ZnO} = -3.63$ eV). HSE values of total energy for bulk metallic Zn yields $\mu_{Zn(metal)} = -2.37$ eV, and that of oxygen molecule $\mu_{O2} = -20.66$ eV. The source of gallium is assumed to be metallic stable orthorhombic phase, for which we obtain $\mu_{Ga} = 3.75$ eV.

From the experimental point of view, O-rich (or Zn-rich) conditions imply that the supply of reactive O atoms exceeds that of Zn atoms (or vice versa). The partial pressures of reactive O or Zn can be estimated from the growth rate (\sim 1.5 nm/min in our case) at 1:1 reactive oxygen-to-metal flux ratio (near-stoichiometric growth conditions), determined from the dependence of growth rate on oxygen pressure at constant Zn flux and taking into account the incorporation efficiency of $\sim 1/3$ of Zn atoms into the ZnO lattice during plasma-assisted MBE on sapphire³⁸. Assuming Zn arrives as a monoatomic reagent, its partial pressure above the ZnO growing surface was estimated to be between 6×10^{-7} and $1 \times$ 10^{-6} Torr. The reaction rate between Zn and molecular O₂ at the growth temperatures is very low; therefore, plasma source is used to generate monoatomic reactive oxygen. The 1:1 ratio of atomic O to Zn is obtained at the total oxygen pressure of 8 to 10×10^{-6} Torr in the growth chamber measured with a vacuum gauge, while the estimated partial pressure of reactive oxygen is slightly below 1×10^{-6} Torr. Assuming the flux of reactive components varies linearly with their partial pressure, the partial pressure of reactive oxygen can be estimated to be 5 \times 10⁻⁷ Torr for Zn-rich conditions (the total oxygen pressure is ~ 4 to 5 \times 10⁻⁶ Torr) and around 3 \times 10^{-6} Torr for oxygen-rich conditions (the total oxygen pressure is 1.5×10^{-5} Torr). This pressure difference is four orders of magnitude larger than the equilibrium oxygen partial pressure over ZnO (1.75 \times 10^{-10} Torr at growth temperature, deduced from the data in Ref. 39), illustrating that experimentally O-rich and O-poor conditions are significantly far apart. These experimental conditions of the plasma enhanced MBE growth are away from thermal equilibrium. Nevertheless, the computed defect formation energies are still physically meaningful, allowing comparison of the theory and the experiment.¹³ Nonequilibrium growth conditions imply that a higher energy defect state can form with concentrations exceeding their equilibrium values. However, defects with high formation energy will always be more difficult to create, since high energy always needs to be spent in order to form them. Since it is difficult to determine the exact correspondence of the partial pressures of reagents to the changes of the chemical potentials during a nonequilibrium growth, we can expect to capture trends between the two limiting growth conditions.

III. RESULTS AND DISCUSSION

Ga is known to be a shallow donor, substituting for Zn in the ZnO lattice (Fig. 1), while interstitial Ga impurities have much larger formation energies. We have tested octahedral, tetrahedral, and two inequivalent hexagonal sites in the ZnO wurtzite lattice as possible sites for Ga_i. The formation energies for Ga_i at these sites differ by a maximum of 0.3 eV, while all of them are much higher than substitutional Ga_{Zn}. For instance, this difference for neutral impurities is 7.88 eV. This implies negligible equilibrium concentrations of the interstitial



FIG. 1. (Color online) (a) Charge densities of the electron trapped at the $(Ga_{Zn}-V_{Zn})^{1-}$ complex and (b) $(Ga_{Zn}-O_i)^{2-}$ complex. The isosurfaces are taken at 6% of the maximum. Both complexes are deep acceptors with low formation energy in the O-rich environment. $(Ga_{Zn}-O_i)^{2-}$ forms three nearly degenerate defect states of the same symmetry (one shown).

Ga impurities. Previous theoretical studies of GaZn in ZnO often were concentrated on Ga as a codopant (with N)⁴⁰⁻⁴² in order to circumvent the doping asymmetry and obtain a stable *p*-type ZnO and (with Co)⁴³ to fabricate ZnO as a dilute magnetic semiconductor. First principles DFT calculations of an isolated Ga_{Zn} impurity yielded a donor thermodynamic transition level at 1.5 eV above the valence band maximum (VBM) using GGA, around 2.1 eV using GGA + U (for U =0.5 eV), and 3.9 eV by using band gap extrapolation formula (introduced in Ref. 20).⁴⁴ We find Ga_{Zn} to be a shallow donor with +/0 thermodynamic transition level being at 3.00 eV above the VBM (Fig. 2). The formation energy of Ga_{Zn}^{0} is -4.02 eV in the O-rich conditions, and -0.67 eV in the O-poor conditions. This implies that O-rich conditions would produce much more abundant numbers of Ga donors in comparison with O-poor conditions. In fact, the experimental picture is the exact opposite. Measured carrier concentrations in samples grown under O-poor conditions are several times to more than one order of magnitude higher than those in



FIG. 2. (Color online) Formation energies of defects as a function of the location of Fermi energy (origin is set at the VBM) in (a) oxygen rich and (b) oxygen poor environment. Positive (negative) slope corresponds to positive (negative) defect charge state. The ends of the formation energy lines correspond to the experimental E_F of Ga heavily doped ZnO, 0.3 eV above the CBM (vertical line).

samples grown under O-rich conditions.^{45–47} In particular, the measured carrier concentrations in our GZO layers grown by PE MBE at $P_{O2} = 4.5 \times 10^{-6}$ Torr (metal-to-reactive oxygen ratio <1⁸) are ~5 to 8 × 10²⁰ cm⁻³, while those in the layers grown at $P_{O2} = 1.5 \times 10^{-5}$ Torr (metal-to-reactive oxygen ratio > 1⁸) are 2 × 10¹⁹ cm⁻³.

Acceptor-like defects, such as interstitial oxygen O_i and zinc vacancy V_{Zn} considered here, have relatively high formation energies (Fig. 2). For both O-rich and O-poor growth regimes at the experimental Fermi levels of approximately 0.3 eV above the conduction band minimum (CBM), the formation energy of V_{Zn} (O_i) acceptor is 3.63 eV (6.48 eV) higher than that of the Ga_{Zn} donor. Therefore, regardless of the growth conditions, the formation energies of these acceptor defects do not suggest any appreciable compensation. Nevertheless, in the samples grown under O-rich conditions, temperature-dependent mobility measurements suggest 94% compensation in as-grown samples (reduced to 66% upon thermal annealing), while the compensation in the layers grown under O-poor conditions ranges from 20 to 30%. Therefore, other mechanisms of compensation must be present.

In order to resolve these inconsistencies, here we suggest that both the compensation mechanism and the conductivity measurements can be explained by involving defect complexes. Due to large concentrations of Ga in our samples the natural candidates for such complexes are the Ga_{Zn} (or Ga_i) donor, V_{Zn} (or O_i) acceptor pairs. Indeed, our hybrid functional calculations show that both the $Ga_{Zn}-V_{Zn}$ and $Ga_{Zn}-O_i$ complexes are deep acceptors with 0/- thermodynamic transition levels at 1.31 eV and 3.15 eV above VBM, respectively. The $Ga_i - V_{Zn}$ complex does not form with Ga_i moving into the Zn vacancy as a result of atomic relaxation. The defect state charge densities for $Ga_{Zn}-V_{Zn}$ and $Ga_{Zn}-O_i$ complexes are shown in Fig. 1, where significant lattice relaxation is evident, suggesting the expected strong acceptor-donor Coulomb interactions. The defect states are derived from the oxygen p-states localized at the acceptor's neighboring O atoms. Thus, in both cases, these acceptor complexes trap the electrons at nearby oxygen sites, while the Ga_{7n} plays a stabilizing role, dramatically reducing the acceptor formation energies.

In the O-rich environment [Fig. 2(a)], for E_F beyond 2.8 eV, the formation energy of the Ga_{Zn}- V_{Zn} complex is significantly lower than that of the Ga_{Zn}. For example, in the most extreme case of E_F at 0.3 eV in the conduction band, this difference reaches 0.85 eV, suggesting that this acceptor is responsible for the observed compensation ratios. Isolated zinc vacancies have been shown to be mobile well below room temperature and readily binding into complexes with other defects.⁴⁸ Therefore, the Ga_{Zn}- V_{Zn} complexes can efficiently form during the cooldown period after growth. The Ga_{Zn}-O_i complex has formation energy that is 1.35 eV higher, and therefore its contribution is less significant.

In the O-poor environment [Fig. 2(b)], the picture is dramatically different. While the formation energies of the Ga_{Zn} donor (and V_{Zn} , O_i acceptors) increase by 3.35 eV due to the differences in Zn chemical potential, the formation energies of Ga_{Zn} - V_{Zn} and Ga_{Zn} - O_i complexes increase by 6.70 eV. In this case, regardless of the Fermi level location, the formation energies of these complexes are, respectively, 2.48 and 4.69 eV



FIG. 3. (Color online) Determining the binding energy of the defect complexes for sample grown in the O-rich environment based on measurements of the temperature-dependent carrier concentrations. The concentrations are plotted in the Arrhenius coordinates, yielding an activation energy $E_a = 0.57$ eV.

higher than that of the Ga_{Zn} donor, and no compensation via these complexes is expected.

These computed defect energetics are in agreement with our experimental data obtained for the GZO layers grown on a-plane sapphire at the same substrate temperature of 400 °C using the same Ga and Zn fluxes but under O-poor condition ($P_{O2} = 4.5 \times 10^{-6}$ Torr) and O-rich condition ($P_{O2} = 1.5 \times 10^{-5}$ Torr). Detailed information on the growth conditions and the effects of rapid thermal annealing (RTA) on the electrical properties of the samples can be found elsewhere.⁸ The resistivities of the layers grown under O-rich and in O-poor conditions are ~4.5 × 10⁻² and ~2.8 × 10⁻⁴ Ω cm, respectively. This is consistent with the results of our hybrid functional calculations predicting a much more efficient formation of acceptor defect complexes under oxygen-rich conditions, providing a compensation mechanism and decreasing the electric conductivity.

We estimate the binding energies of $Ga_{Zn}-V_{Zn}$ and $Ga_{Zn}-O_i$ complexes as the formation energy difference of a complex and its constituents. In our O-rich grown samples, the carrier concentration is 2.0×10^{19} cm⁻³, placing the Fermi level approximately at 0.1 eV below the CBM. In this case, the $Ga_{Zn}-V_{Zn}$ binding energy is 0.75 eV, and that of $Ga_{Zn}-O_i$ is 0.66 eV. These binding energies are in reasonable agreement with the measured value of 0.57 eV, obtained from the temperature-dependent concentrations shown in Fig. 3. Upon the RTA treatment in the temperature range from 400 to 550 °C, resistivity of the samples grown under O-rich conditions reduced to ${\sim}5.7~{\times}~10^{-4}~\Omega$ cm, and the compensation ratio calculated by the method reported by Look et al.⁴⁹ decreased from \sim 94 to \sim 66%. The reduction in the resistivity upon annealing is mainly due to the increases in carrier concentration (shown in Fig. 3), while mobilities in the annealed samples slightly varied around 20 cm²/Vs. The increase in carrier concentration of the annealed GZO layers is likely due to the dissociation of Ga_{Zn} - V_{Zn} and/or Ga_{Zn} - O_i complexes. The carrier concentration in the samples annealed in the temperature range from 425 to 550 °C follows the Arrhenius law (see the inset in Fig. 3), and binding energy of defect complexes was found to be $\sim 0.57 \pm 0.2$ eV. (Further increase in annealing temperature from 550 to 650 °C leads to the gradual decrease in the carrier concentrations in all samples, likely due to the decrease in structural quality of the material.)

IV. CONCLUSIONS

In summary, we have shown through hybrid functional calculations that inclusion of impurity complexes is crucial for understanding the electric properties of heavily doped ZnO. We find that the measured conductivity data cannot be explained by the isolated impurities alone. On the other hand, the computed electronic properties of impurity complexes provide a picture, which is in agreement with the measured conductivity, compensation ratios, and binding energies. In the O-rich environment, the formation energies of the acceptor $Ga_{Zn}-V_{Zn}$ and $Ga_{Zn}-O_i$ complexes are significantly lower than that of the donor GaZn. This provides an efficient mechanism for experimentally observed high compensation ratios and lower conductivity. In the O-poor environment, the complex formation energies are 6.70 eV higher, indicating that in this case these complexes do not form, which leads to much larger values of carrier concentrations and conductivity.

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